

Vishay Siliconix

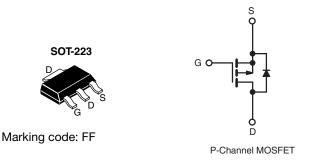
COMPLIANT

HALOGEN

FREE

Power MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V)	-10	0
$R_{DS(on)}(\Omega)$	V _{GS} = -10 V	1.2
Q _g (Max.) (nC)	8.7	
Q _{gs} (nC)	2.2	
Q _{gd} (nC)	4.1	
Configuration	Sing	le



FEATURES

- Surface mount
- Available in tape and reel
- Dynamic dV/dt rating
- · Repetitive avalanche rated
- P-channel
- · Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOT-223 package is designed for surface-mount using vapor phase, infrared, or wave soldering techniques. Its unique package design allows for easy automatic pick-and-place as with other SOT or SOIC packages but has the added advantage of improved thermal performance due to an enlarged tab for heatsinking. Power dissipation of greater than 1.25 W is possible in a typical surface mount application.

ORDERING INFORMATION		
Package	SOT-223	SOT-223
Lead (Pb)-free and Halogen-free	SiHFL9110-GE3	SiHFL9110TR-GE3 a
Lead (Pb)-free	IRFL9110PbF	IRFL9110TRPbF ^a
	SiHFL9110-E3	SiHFL9110T-E3 a

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (To	; = 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	-100	V		
Gate-Source Voltage		V_{GS}	± 20	v		
Continuous Drain Current	V at 10.V	T _C = 25 °C	1	-1.1		
Continuous Drain Current	V _{GS} at - 10 V	$T_C = 25 \degree C$ $T_C = 100 \degree C$	I _D	-0.69	A	
Pulsed Drain Current ^a			I _{DM}	-8.8		
Linear Derating Factor				0.025	W/°C	
Linear Derating Factor (PCB Mount) e				0.017	- W/ C	
Single Pulse Avalanche Energy b			E _{AS}	100	mJ	
Avalanche Current a			I _{AR}	-1.1	Α	
Repetitive Avalanche Energy ^a			E _{AR}	0.31	mJ	
Maximum Power Dissipation	T _C =	T _C = 25 °C		3.1	W	
Maximum Power Dissipation (PCB Mount) e	T _A =	T _A = 25 °C		2.0	VV	
Peak Diode Recovery dV/dt c	•		dV/dt	-5.5	V/ns	
Operating Junction and Storage Temperature Range	ge		T _J , T _{stg}	-55 to +150	°C	
Soldering Recommendations (Peak Temperature)	for	10 s	_	300		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = -25 V, starting T_J = 25 °C, L = 7.7 mH, R_g = 25 Ω , I_{AS} = -4.4 A (see fig. 12).
- c. $I_{SD} \le -4.4 \text{ A}$, $dI/dt \le -75 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 150 \,^{\circ}\text{C}$.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).



Vishay Siliconix

THERMAL RESISTANCE RATI	NGS				
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	60	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1	40	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V_{DS}	V _{GS} =	= 0 V, I _D = -250 μA	-100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = -1 mA	-	-0.091	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = -250 μA	-2.0	-	-4.0	V
Gate-Source Leakage	I_{GSS}		$V_{GS} = \pm 20 \text{ V}$	1	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		-100 V, V _{GS} = 0 V V, V _{GS} = 0 V, T _J = 125 °C	-	-	-100 - 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = -10 V		-	-	1.2	Ω
Forward Transconductance	9 _{fs}		-50 V, I _D = -0.66 A	0.82		-	S
Dynamic					l	l	
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	200	-	
Output Capacitance	C _{oss}		V _{GS} = 0 V, V _{DS} = - 25 V, f = 1.0 MHz, see fig. 5		94	-	рF
Reverse Transfer Capacitance	C _{rss}	f = 1			18	-	1
Total Gate Charge	Qq			-	-	8.7	
Gate-Source Charge	Q _{gs}	$V_{GS} = -10 \text{ V}$ $I_D = -4.0 \text{ A}, V_{DS} = -80 \text{ V},$ see fig. 6 and 13 b		-	-	2.2	nC
Gate-Drain Charge	Q _{gd}		See lig. 0 and 10	-	-	4.1	1
Turn-On Delay Time	t _{d(on)}			-	10	-	
Rise Time	t _r	V_{DD} = -50 V, I_{D} = -4.0 A, R_{G} = 24 Ω , R_{D} = 11 Ω , see fig. 10 b		-	27	-	ns
Turn-Off Delay Time	t _{d(off)}			-	15	-	
Fall Time	t _f			-	17	-	
Internal Drain Inductance	L_D		Between lead, 6 mm (0.25") from		4.0	-	
Internal Source Inductance	L _S	package and center of die contact		-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		1	-	-1.1	Α
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction	· · ·	-	-	-8.8	^
Body Diode Voltage	V _{SD}	T _J = 25 °C,	$I_S = -1.1 \text{ A}, V_{GS} = 0 \text{ V}^{\text{ b}}$	-	-	-5.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 °C 1	4.0.4 dl/d+ 400.4/: h	-	80	160	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = -4.0 \text{A}, dI/dt = 100 \text{A}/\mu \text{s}^{ \text{b}}$		-	0.15	0.30	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	ırn-on time is negligible (turn	on is dor	ninated b	y L _S and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

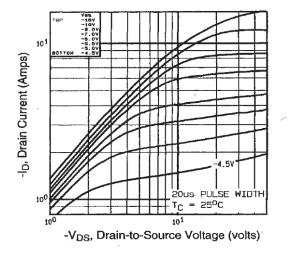


Fig. 1 - Typical Output Characteristics

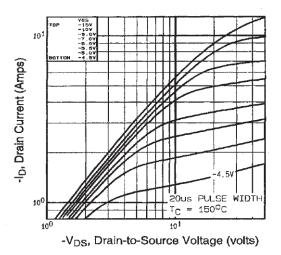


Fig. 2 - Typical Output Characteristics

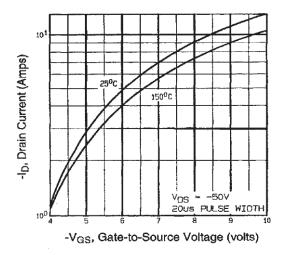


Fig. 3 - Typical Transfer Characteristics

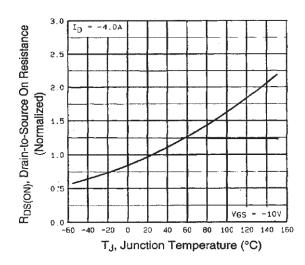


Fig. 4 - Normalized On-Resistance vs. Temperature



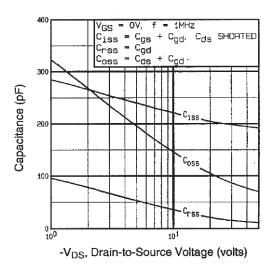


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

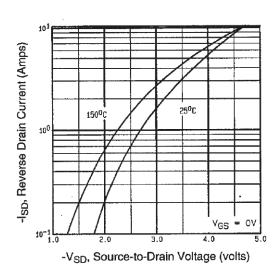


Fig. 7 - Typical Source-Drain Diode Forward Voltage

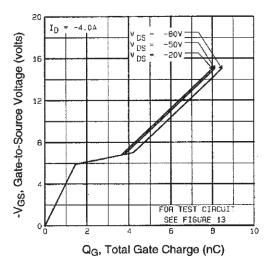


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

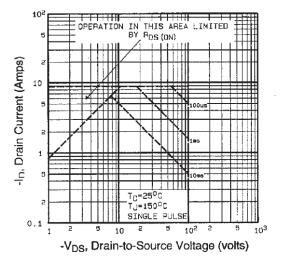


Fig. 8 - Maximum Safe Operating Area



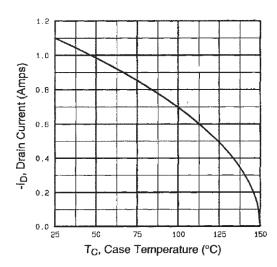


Fig. 9 - Maximum Drain Current vs. Case Temperature

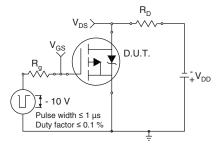


Fig. 10a - Switching Time Test Circuit

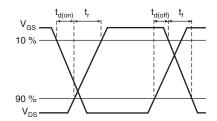


Fig. 10b - Switching Time Waveforms

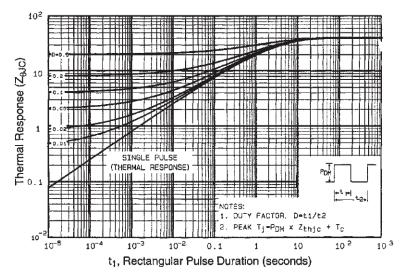


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



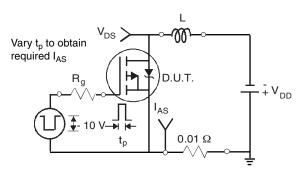


Fig. 12a - Unclamped Inductive Test Circuit

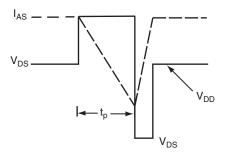


Fig. 12b - Unclamped Inductive Waveforms

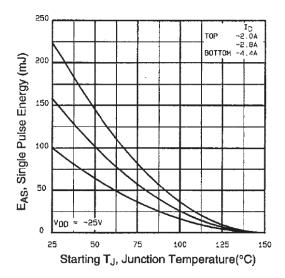


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

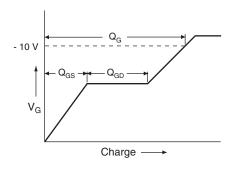


Fig. 13a - Basic Gate Charge Waveform

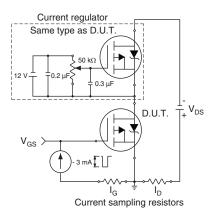
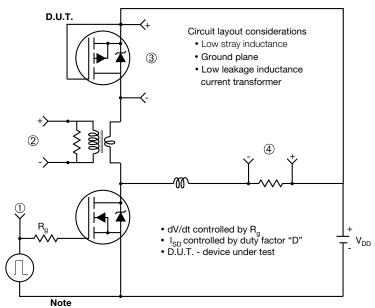


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

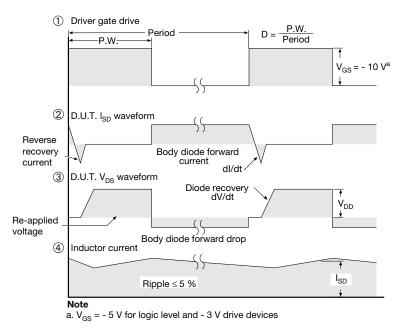


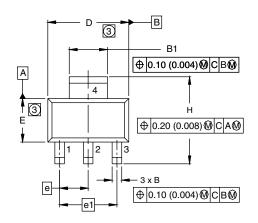
Fig. 14 - For P-Channel

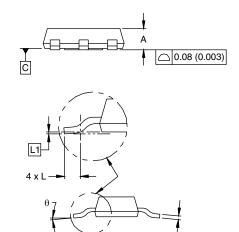
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91196.



Vishay Siliconix

SOT-223 (HIGH VOLTAGE)





DIM.	MILLI	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	1.55	1.80	0.061	0.071	
В	0.65	0.85	0.026	0.033	
B1	2.95	3.15	0.116	0.124	
С	0.25	0.35	0.010	0.014	
D	6.30	6.70	0.248	0.264	
E	3.30	3.70	0.130	0.146	
е	2.30 BSC		0.0905	BSC	
e1	4.60 BSC		0.181	BSC	
Н	6.71	7.29	0.264	0.287	
L	0.91	-	0.036	=	
L1	0.061 BSC		0.0024	BSC	
θ	-	10'	-	10'	

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Revision: 13-Jun-16 1 Document Number: 91000

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay:

IRFL9110TRPBF IRFL9110 IRFL9110TR IRFL9110PBF